

### **CELCON®**

Celcon® WR90Z is a medium flow acetal copolymer stabilized to provide maximum ultraviolet radiation resistance in outdoor applications while retaining a good balance of properties. Available in black only.

$\Box$	-	٦.		100			
$\mathbf{r}$	I ()	СП	Ю	II II	()[	mat	IOI I
•	. •	٠,	401		0.	mat	

Resin Identification Part Marking Code	POM >POM<		ISO 1043 ISO 11469
Rheological properties			
Melt volume-flow rate Temperature Load Moulding shrinkage, parallel Moulding shrinkage, normal	8 190 2.16 2.2 1.9	kg %	ISO 1133 ISO 294-4, 2577 ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus Tensile stress at yield, 50mm/min Tensile strain at yield, 50mm/min Flexural modulus Flexural stress at 3.5% Compressive stress at 1% strain Charpy impact strength, 23°C Charpy notched impact strength, 23°C Charpy notched impact strength, -30°C Izod notched impact strength, 23°C Poisson's ratio	8 2550 70 31 99 5.5 5.3	MPa %	ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 178 ISO 178 ISO 604 ISO 179/1eU ISO 179/1eA ISO 179/1eA
Thermal properties			
Melting temperature, 10°C/min Temperature of deflection under load, 1.8 MPa Temperature of deflection under load, 0.45 MPa Coefficient of linear thermal expansion (CLTE), parallel Coefficient of linear thermal expansion (CLTE), normal	152 100	°C	ISO 11357-1/-3 ISO 75-1/-2 ISO 75-1/-2 ISO 11359-1/-2
Physical/Other properties			
Water absorption, Immersion 24h Density	0.2 1410	% kg/m³	Sim. to ISO 62 ISO 1183
Injection			
Drying Recommended Drying Temperature Drying Time, Dehumidified Dryer Processing Moisture Content Melt Temperature Optimum Min. melt temperature Max. melt temperature	no 100 3 - 4 ≤0.2 190 180 200	h % °C °C	

Printed: 2024-09-06 Page: 1 of 6



#### **CELCON®**

Screw tangential speed≤0.3 m/sMold Temperature Optimum100 °CMin. mould temperature80 °CMax. mould temperature120 °CHold pressure range60 - 120 MPaBack pressure4 MPa

#### Additional information

Injection molding

#### Preprocessing

Drying is generally not required because Celcon® and Hostaform® acetal copolymers are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to splay (silver streaking) in molded parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = 0.35%

#### **Processing**

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.

#### Postprocessing

Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.

**Processing Notes** 

#### **Pre-Drying**

Drying is not normally required. If material has come in contact with moisture

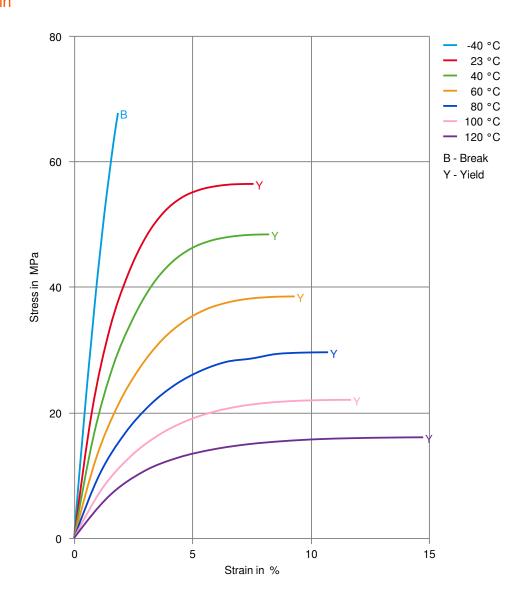
Printed: 2024-09-06 Page: 2 of 6



**CELCON®** 

through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

#### Stress-strain

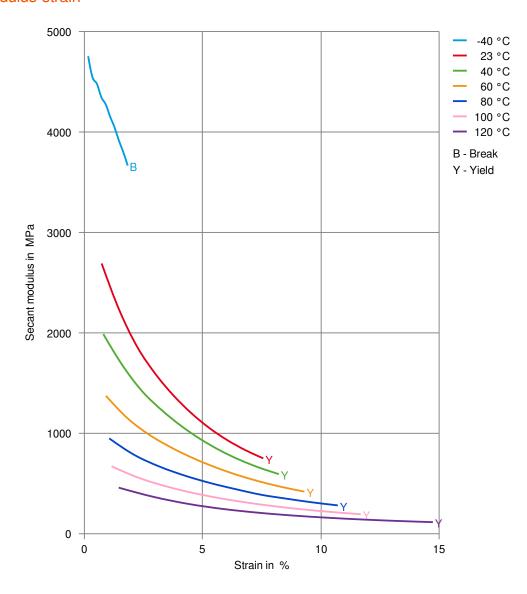


Printed: 2024-09-06 Page: 3 of 6



### **CELCON®**

#### Secant modulus-strain

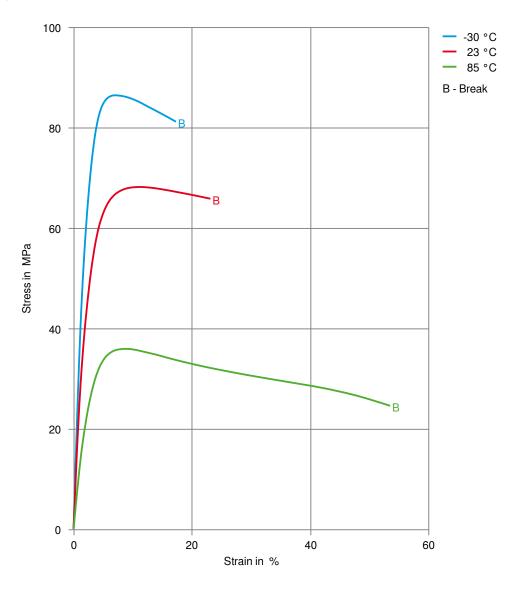


Printed: 2024-09-06 Page: 4 of 6



### **CELCON®**

#### Stress-strain, 50mm/min

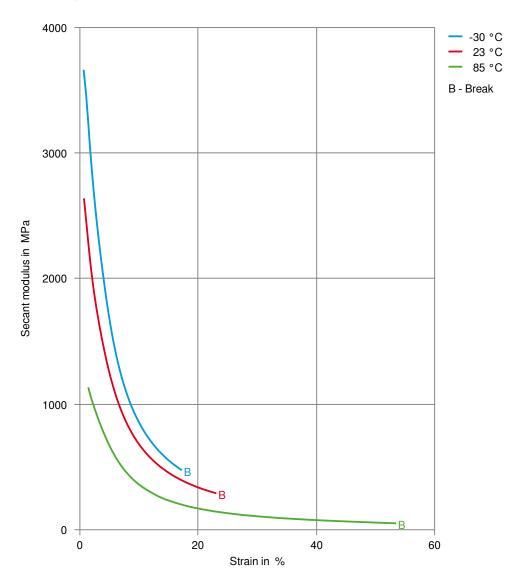


Printed: 2024-09-06 Page: 5 of 6



#### **CELCON®**

#### Secant modulus-strain, 50mm/min



Printed: 2024-09-06 Page: 6 of 6

Revised: 2024-07-08 Source: Celanese Materials Database

NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colourants or other additives may cause significant variations in data values. Properties of moulded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design, processing conditions and environmental exposure. Other than those products expressly identified as medical grade (including by MT® product designation or otherwise), Celanese's products are not intended for use in medical or dental implants. Regardless of any such product designation, any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. The information contained in this publication should not be construed as a promise or guarantee of specific properties of our products. It is the sole responsibility of the users to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication. Moreover, there is a need to reduce human exposure to many materials to the lowest practical limits in view of possible adverse effects. To the extent that any hazards may have been mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommendation or to use any e

© 2024 Celanese or its affiliates. All rights reserved. Celanese®, registered C-ball design and all other trademarks identified herein with ®, TM, SM, unless otherwise noted, are trademarks of Celanese or its affiliates. Fortron is a registered trademark of Fortron Industries LLC. KEPITAL is a registered trademark of Korea Engineering Plastics Company, Ltd.